

# Product data sheet

Specifications



redundant processor, Modicon M580, 64MB, 61 Ethernet devices, 31 remote IO racks of X80 and Quantum, conformal coating

BMEH586040C

## Main

Range of product	Modicon M580
Product or component type	Redundant processor module
Impregnation material	Conformal coated

## Complementary

Number of racks	1
Application specific I/O	Serial link Accurate time stamping SSI encoder Motion control HART Counter
Checks	Process control
Control channels	Programmable loops
Integrated connection type	1 Ethernet TCP/IP for service port 2 Ethernet TCP/IP for device network USB type mini B 1 Ethernet for HSBY port
Number of remote I/O station	31 - 2 rack(s) per X80 and Quantum drops
Number of distributed equipment	64
Communication module processor capacity	6 Ethernet communication module 16 AS-Interface module
Communication service	RIO scanner DIO scanner
Memory description	Expandable flash, 4 GB for data storage Integrated RAM, 10 kB for system memory Integrated RAM, 64 MB for program and data Integrated RAM, 4096 kB for HSBY data
Application structure	1 periodic fast task 1 cyclic/periodic master task
Number of instructions per ms	40 Kinst/ms 100 % Boolean 50 Kinst/ms 65 % Boolean + 35 % fixed arithmetic
Current consumption	365 mA at 24 V DC
MTBF reliability	650000 H
Marking	CE

## Environment

Vibration resistance	3 gn
Shock resistance	30 gn

<b>Ambient air temperature for operation</b>	-25...60 °C
<b>Ambient air temperature for storage</b>	-40...85 °C
<b>Operating altitude</b>	0...2000 m 2000...5000 m with derating factor
<b>Relative humidity</b>	5...95 % at 55 °C without condensation
<b>IP degree of protection</b>	IP20
<b>Directives</b>	2014/35/EU - low voltage directive 2014/30/EU - electromagnetic compatibility 2014/34/EU - ATEX directive
<b>Product certifications</b>	CE UL CSA RCM EAC Merchant Navy ATEX zone 2/22 IECEx zone 2/22
<b>Standards</b>	IEC 61131-2 IEC 61010-2-201 UL 61010-2-201 CSA C22.2 No 61010-2-201 IACS E10 EN/IEC 61000-6-5, interface type 1 and type 2 EN/IEC 61850-3, location G IEC 60079-0
<b>Environmental characteristic</b>	Gas resistant class Gx conforming to ISA S71.04 Gas resistant class 3C4 conforming to IEC 60721-3-3 Dust resistant class 3S4 conforming to IEC 60721-3-3 Sand resistant class 3S4 conforming to IEC 60721-3-3 Salt resistant level 2 conforming to IEC 68252 Mold growth resistant class 3B2 conforming to IEC 60721-3-3 Fungal spore resistant class 3B2 conforming to IEC 60721-3-3 Hazardous location class I division 2
<b>Protective treatment</b>	Conformal coating
<b>Supply</b>	Internal power supply via rack
<b>Status LED</b>	1 LED (green) processor running (RUN) 1 LED (red) processor or system fault (ERR) 1 LED (red) I/O module fault (I/O) 1 LED (green) download in progress (DL) 1 LED (red) memory card or CPU flash fault (BACKUP) 1 LED (green/red) ETH MS (Ethernet port configuration status) 1 LED (green/red) Eth NS (Ethernet network status) 1 LED (green) peer processor running (REMOTE RUN) 1 LED (green) processor ID set to A (A) 1 LED (green) processor ID set to B (B) 1 LED (green) processor acting as Primary (PRIM) 1 LED (green) processor acting as Standby (STBY) 1 LED (green) I/O values overridden by user (FORCED IO) 1 LED (green) Hot standby link status (Hsby Diag)
<b>Net weight</b>	0.849 kg

## Packing Units

<b>Unit Type of Package 1</b>	PCE
<b>Number of Units in Package 1</b>	1
<b>Package 1 Height</b>	8.800 cm
<b>Package 1 Width</b>	17.800 cm
<b>Package 1 Length</b>	25.200 cm
<b>Package 1 Weight</b>	891.000 g
<b>Unit Type of Package 2</b>	S03

<b>Number of Units in Package 2</b>	6
<b>Package 2 Height</b>	30.000 cm
<b>Package 2 Width</b>	30.000 cm
<b>Package 2 Length</b>	40.000 cm
<b>Package 2 Weight</b>	5.878 kg

## Environmental Data

Schneider Electric aims to achieve Net Zero status by 2050 through supply chain partnerships, lower impact materials, and circularity via our ongoing “Use Better, Use Longer, Use Again” campaign to extend product lifetimes and recyclability.

[Environmental Data explained >](#)

[How we assess product sustainability >](#)

### Environmental footprint

Total lifecycle Carbon footprint 290

Environmental Disclosure [Product Environmental Profile](#)

## Use Better

### Materials and Substances

Packaging made with recycled cardboard Yes

Packaging without single use plastic No

[EU RoHS Directive](#) Pro-active compliance (Product out of EU RoHS legal scope)

SCIP Number 4eb70ab0-978b-4773-a441-0cc20d6144a1

REACH Regulation [REACH Declaration](#)

California proposition 65 **WARNING:** This product can expose you to chemicals including: Lead and lead compounds, which is known to the State of California to cause cancer and birth defects or other reproductive harm. For more information go to [www.P65Warnings.ca.gov](http://www.P65Warnings.ca.gov)

## Use Again

### Repack and remanufacture

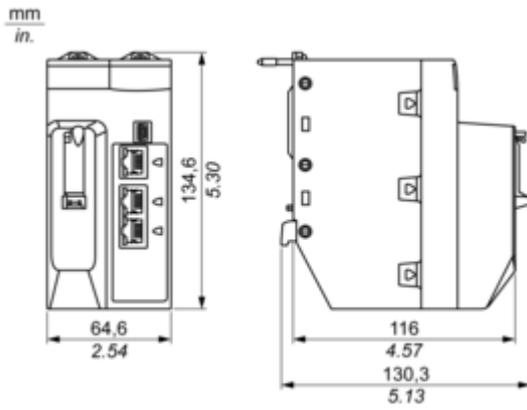
End of life manual availability [End of Life Information](#)

Take-back No

Dimensions Drawings

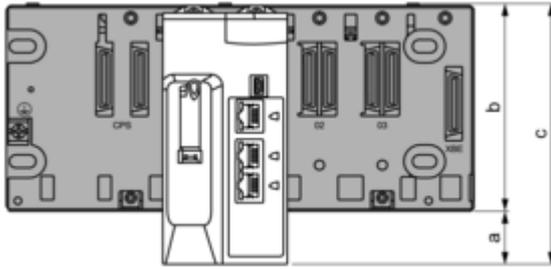
CPU Module Only

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**Modules Mounted on Racks**

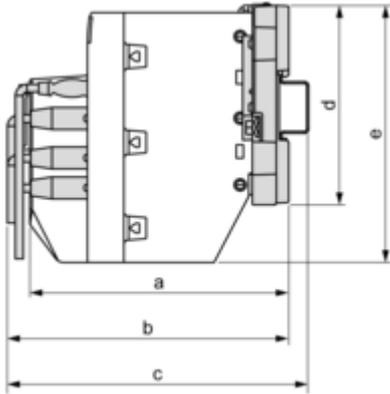
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- a:** additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the value is 29.49 mm (1.161 in.).
- b:** the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).
- c:** the height of the main local rack, 134.6 mm (5.299 in.)

**Modules and Cables Mounted in an Enclosure**

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**a:** enclosure depth: 135 mm (5.315 in.)

**b:** wiring + module depth: > 146 mm (5.748 in.)

**c:** wiring + module + DIN rail depth: > 156 mm (6.142 in.)

**d:** rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.)

**e:** module height: 134.6 mm (5.299 in.)

Image of product / Alternate images

Alternative

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